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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/729,882	12/05/2003	Werner Kroninger	10808/116	9196	
757	7590 03/21/2006		EXAMINER		
	BRINKS HOFER GILSON & LIONE			OSELE, MARK A	
	P.O. BOX 10395 CHICAGO, IL 60610 ART UNIT PAPER NÚM		PAPER NÚMBER		
			1734		
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DATE MAILED: 03/21/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)		
Office Action Summary		10/729,882	KRONINGER ET AL.		
		Examiner	Art Unit		
		Mark A. Osele	1734		
Period fe	The MAILING DATE of this communication a	oppears on the cover sheet w	ith the correspondence address		
A SH WHIC - Exte after - If NC - Failu Any	IORTENED STATUTORY PERIOD FOR REF CHEVER IS LONGER, FROM THE MAILING ensions of time may be available under the provisions of 37 CFR of SIX (6) MONTHS from the mailing date of this communication. Of period for reply is specified above, the maximum statutory period care to reply within the set or extended period for reply will, by state reply received by the Office later than three months after the mailed patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNI 1.136(a). In no event, however, may a od will apply and will expire SIX (6) MON tute, cause the application to become Al	CATION. reply be timely filed  NTHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).		
Status					
1)🛛	Responsive to communication(s) filed on 17	January 2006.			
2a) <u></u> ☐	This action is <b>FINAL</b> . 2b) ☑ This action is non-final.				
3)	• •				
	closed in accordance with the practice unde	r <i>Ex parte Quayle</i> , 1935 C.E	D. 11, 453 O.G. 213.		
Disposit	ion of Claims				
5)	Claim(s) <u>1-23</u> is/are pending in the application 4a) Of the above claim(s) is/are withdrawing Claim(s) is/are allowed. Claim(s) <u>1-23</u> is/are rejected.				
	Claim(s) is/are objected to.				
	Claim(s) are subject to restriction and	l/or election requirement.			
Applicat	ion Papers				
	The specification is objected to by the Exami	ner			
•	The drawing(s) filed on is/are: a) a		by the Examiner.		
•—	Applicant may not request that any objection to the		•		
441	Replacement drawing sheet(s) including the corre	•	• •		
11)[	The oath or declaration is objected to by the	Examiner. Note the attached	d Office Action or form P10-152.		
Priority (	under 35 U.S.C. § 119				
•	Acknowledgment is made of a claim for foreign All b) Some * c) None of:  1. Certified copies of the priority docume		§ 119(a)-(d) or (f).		
	Certified copies of the priority docume     Certified copies of the priority docume		Application No.		
	3. Copies of the certified copies of the pr		·· ———		
	application from the International Bure	eau (PCT Rule 17.2(a)).	•		
* 5	See the attached detailed Office action for a li	st of the certified copies not	received.		
Attachmen	nt(s)				
1) 🔲 Notic	ce of References Cited (PTO-892)		Summary (PTO-413)		
_	ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/0	. —	s)/Mail Date nformal Patent Application (PTO-152)		
	mation disclosure statement(s) (PTO-1449 of PTO/SB/0		oa. r atone application (1 10-102)		

### **DETAILED ACTION**

# Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-23 are rejected under 35 U.S.C. 103(a) as being unpatentable over De (U.S. Patent 6,470,946) in view of Buchwalter et al. (U.S. Patent Publication 2002/0078559) and Hiyamizu et al. (U.S. Patent 4,906,011). De shows the method of processing a semiconductor workpiece, 402, by adhering the workpiece with an adhesive, 404, to a porous work carrier, 406, (column 5, lines 46-51) having through holes, 428, thinning the workpiece (column 1, lines 26-31), and then applying solvent through the porous work carrier to dissolve the adhesive (column 5, lines 63-67; column 6, lines 24-30) and separate the workpiece from the carrier (column 6, lines 36-55). De is silent as to the exact adhesive used, but teaches that various adhesives including epoxy and tape are conventionally used to adhere a wafer to a carrier (column 1, lines 33-40). De fails to show the porous carrier to have interconnected pores.

Buchwalter et al. teaches the use of a porous carrier, 404, can be used with adhesive to hold semiconductor elements to the carrier. Buchwalter et al. further teaches that a fluid can penetrate the porous carrier to release the elements from the carrier (paragraph 0053). It would have been obvious to one of ordinary skill in the art at the time the invention was made to use the porous carrier of Buchwalter et al. with

interconnected pores as the carrier in the process of De because Buchwalter et al. teaches the similar construction and function of a porous carrier with interconnected pores to the porous carrier of De which does not have interconnected pores.

Hiyamizu et al. teaches that the depth of infiltration of adhesive into the pores of a porous vacuum chuck can be controlled by selecting parameters including the type and viscosity of the adhesive (column 3, lines 26-30). The choosing of an adhesive based upon its viscosity is a clear indication that the anticipated adhesives are in liquid form. It would have been obvious to one of ordinary skill in the art at the time the invention was made to use a liquid adhesive in the method of the references as combined because De suggests that liquid adhesives are conventionally used for holding a wafer to a carrier and Hiyamizu et al. shows that liquid adhesives are used to hold articles to porous vacuum chucks.

Regarding claim 5, De shows the instantly claimed features but fails to disclose of what material the porous carrier is made. It is well known that metal carriers for thinning wafers are conventional. It would have been obvious to one of ordinary skill in the art at the time the invention was made to use any conventional material, such as metal for the carrier of De because these materials are conventionally used.

Regarding claims 12-13, Buchwalter et al. teaches that semiconductor devices can be held on a porous carrier by vacuum, adhesive, or both (paragraph 0053). It would have been obvious to one of ordinary skill in the art at the time the invention was made to use vacuum in addition to the adhesive as it is applied to the carrier of De

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because Buchwalter et al. teaches that these can be used concurrently which would increase the holding strength of the carrier to the semiconductor wafer.

Regarding claim 15, De further shows that a positive pressure can be applied on a side of the work carrier remote from the carrier (column 7, lines 28-49).

Regarding claim 11, which is depends from apparatus claim 10, material worked upon limitations are not given patentable weight in an apparatus claim.

Regarding claims 16-23 the references as combined show the claimed limitations but fail to show the particular pore size and porosity. Hiyamizu et al. teaches that the porosity and pore size of a vacuum carrier is a result effective variable for such factors as adhesive infiltration (column 3, lines 26-39). It would have been obvious to one of ordinary skill in the art at the time the invention was made to design the carrier of the references as combined using routine optimization to determine the most effective pore size and porosity for the carrier for a given situation because Hiyamizu et al. teaches these variables to be situation specific.

## Response to Arguments

3. Applicant's arguments with respect to claims 1-23 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Mark A. Osele whose telephone number is 571-272-1235. The examiner can normally be reached on M-F 9:30-6:00.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Christopher Fiorilla can be reached on 571-272-1187. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

MARK A. OSELE PRIMARY EXAMINER

March 19, 2006